

June 2006

## FFB20UP20S

### **Features**

- Ultrafast Recovery, T<sub>rr</sub> = 45 ns (@ I<sub>F</sub> = 20 A)
- Max Forward Voltage,  $V_F = 1.15 \text{ V}$  (@  $T_C = 25^{\circ}\text{C}$ )
- Reverse Voltage : V<sub>RRM</sub> = 200 V
- · Avalanche Energy Rated
- · RoHS Compliant

## **Applications**

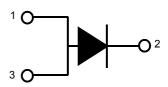
- · Output Rectifiers
- · Switching Mode Power Supply
- · Free-Wheeling Diode for Motor Application
- · Power Switching Circuits

# 20 A, 200 V, Ultrafast Diode

The FFB20UP20S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applicationa as welder and UPS application.



1.Anode 2.Cathode 3.Anode



1. Anode 2. Cathode 3. Anode

## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V
$V_{RWM}$	Working Peak Reverse Voltage	200	V
V <sub>R</sub>	DC Blocking Voltage	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 115°C	20	A
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	200	A
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### **Thermal Characteristics**

Symbol	Parameter	Max	Unit	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.0	°C/W	

## **Package Marking and Ordering Information**

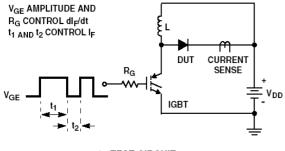
<b>Device Marking</b>	Device	Package	Reel Size	Tape Width	Quantity
F20UP20S FFB20UP20STI		D2-PAK	13" Dia	-	800

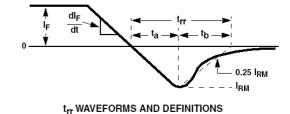
## Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Unit
V <sub>F</sub> *	I <sub>F</sub> = 20 A I <sub>F</sub> = 20 A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	1.15 1.0	V V
I <sub>R</sub> *	V <sub>R</sub> = 200 V V <sub>R</sub> = 200 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	100 500	μ <b>Α</b> μ <b>Α</b>
t <sub>rr</sub>	$I_F$ =1 A, di/dt = 100 A/ $\mu$ s, V <sub>CC</sub> = 30 V $I_F$ =20 A, di/dt = 200 A/ $\mu$ s, V <sub>CC</sub> = 130 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	-	-	35 45	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F = 20 \text{ A}, \text{ di/dt} = 200 \text{ A/}\mu\text{s}, \text{ V}_{CC} = 130 \text{ V}$	$T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$	- - -	11 13 21	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 40mH)		20	-	-	mJ

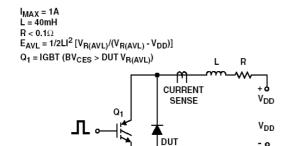
<sup>\*</sup>Pulse Test: Pulse Width=300  $\mu$ s, Duty Cycle=2%

## **Test Circuit and Waveforms**

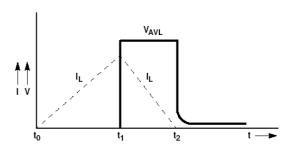




t<sub>rr</sub> TEST CIRCUIT



**AVALANCHE ENERGY TEST CIRCUIT** 



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop

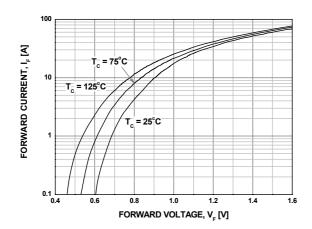


Figure 2. Typical Reverse Current

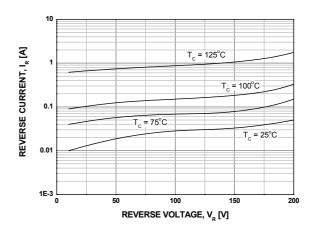


Figure 3. Typical Junction Capacitance

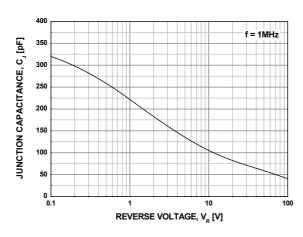


Figure 4. Typical Reverse Recovery Time

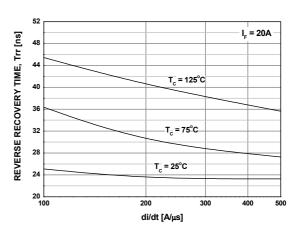
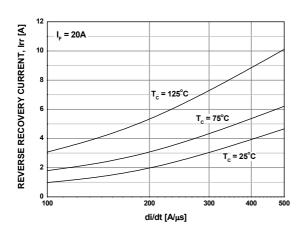
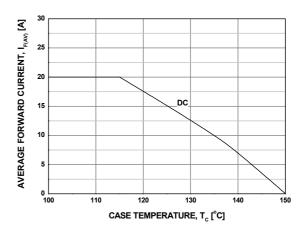


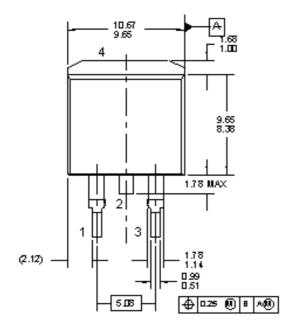
Figure 5. Typical Reverse Recovery Current

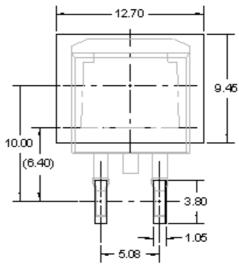


**Figure 6. Forward Current Deration Curve** 

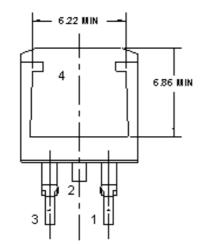


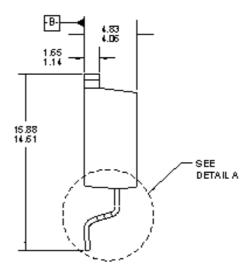
### **Mechanical Dimensions**





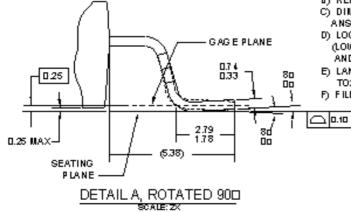
LAND PATTERN RECOMMENDATION UNLESS NOTED, ALL DIMS TYPICAL





NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS. B) REFERENCE JEDBC, TO-263, VARIATION AB.
- C) DIMENSIONING AND TO LERANCING PER ANSI Y1 4.5 M - 1994.
- D) LOCATION OF THE PIN HOLE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE).
- E) LANDPATTERN RECOMMENDATION PER IPC TO25 4P 152 4X 482-3 N
- F) FILENAME: TO 263AD2REV6



Dimensions in Millimeters





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Definition of Terms					
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